

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention

METHOD FOR FORMING ROBUST SOLDER INTERCONNECT
STRUCTURES BY REDUCING EFFECTS OF SEED LAYER
UNDERETCHING

Application Number :

Date :

First Named Applicant: Kamalesh K. Srivastava

Confirmation Number:

Attorney Docket Number: FIS920030359US1

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Submitted By:	Elec. Sign.	Sign. Capacity
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Documents being submitted:	Files
us-fee-sheet	FIS920030359US1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-ids	FIS920030359US1-usidst.xml us-ids.dtd us-ids.xsl
us-assignment	FIS920030359US1-usassn.xml us-assignment.xsl us-assignment.dtd afis9030359us1assign1of4a.tif afis9030359us1assign2of4a.tif afis9030359us1assign3of4a.tif afis9030359us1assign4of4a.tif
us-request	FIS920030359US1-usrequ.xml us-request.dtd us-request.xsl
us-declaration	aFIS920030359us1dec1.tif
us-declaration	aFIS920030359us1dec2.tif
us-declaration	afis92030359us1dec3.tif
us-declaration	afis92030359us1dec4.tif
us-declaration	afis92030359us1dec5.tif
us-declaration	afis92030359us1dec6.tif
application-body	FIS92030359US1-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent

soextblx.dtd
aFIS920030359us1table1.tif
fis920030359us1tbl12of2.tif
fis920030359us1drw1of14.tif
fis920030359us1drw2of14.tif
fis920030359us1drw3of14.tif
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Comments

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